

MCP-2007



MCP-based detector at FLASH for wavelength range down to 5 nm

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FLASH Meeting, March 20, 2007

- Dedicated for:
- Search SASE
- Characterization of radiation
- Desirable to control radiation intensity during user's run

Four iterations for MCP-based detector up to now:

- MCP detector at TTF FEL, Phase I (2000-2002, RAFEL, good performance)
- MCP detector at TTF FEL, Phase I (2001-2002, dedicated, bad performance due to strong gamma-background)
- MCP detector at FLASH (2004-, wavelength range down to 13 nm (good performance)
- MCP detector at PGM beamline (2006-, good performance)

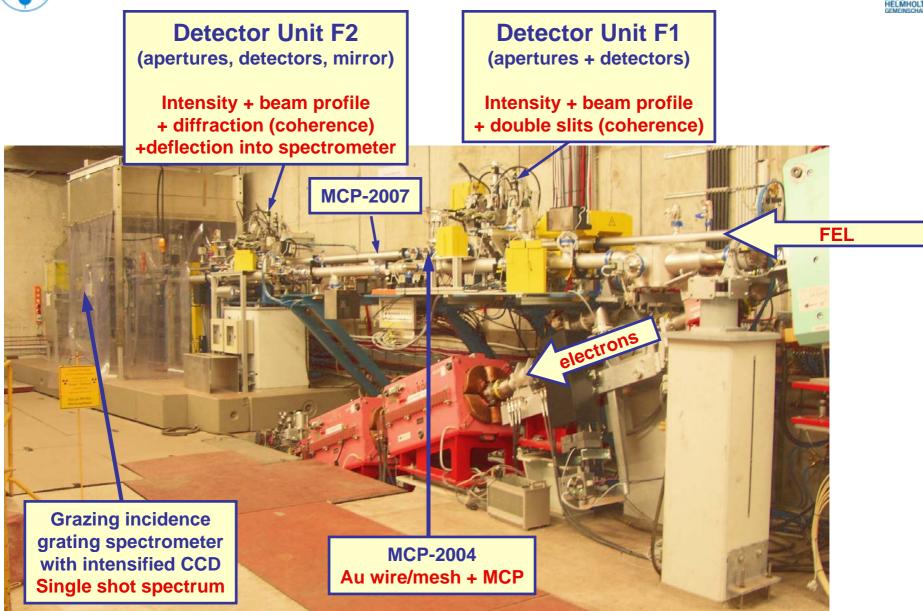
New design (planned for installation in August, 2007)

- MCP-2007: wavelength range down to 5 nm



Photon diagnostics of VUV FEL



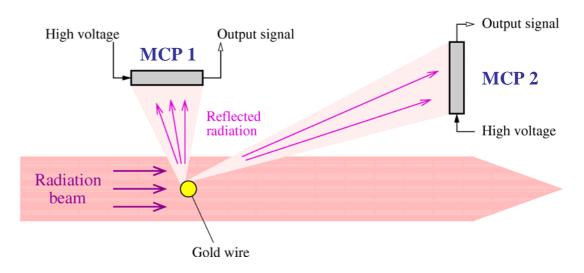




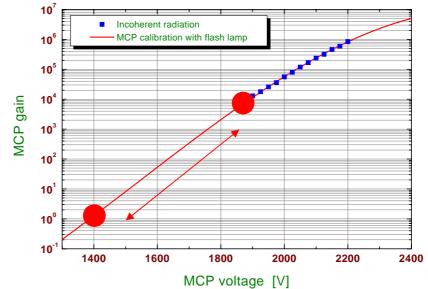














10³

10²

10¹

10[°]

10

1400

1600

1800

MCP voltage [V]

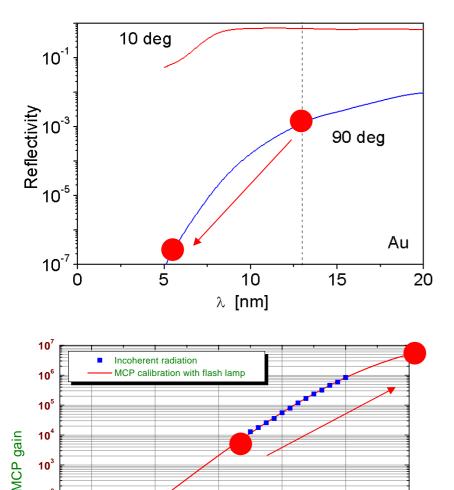
2000

2200

2400

MCP-2004





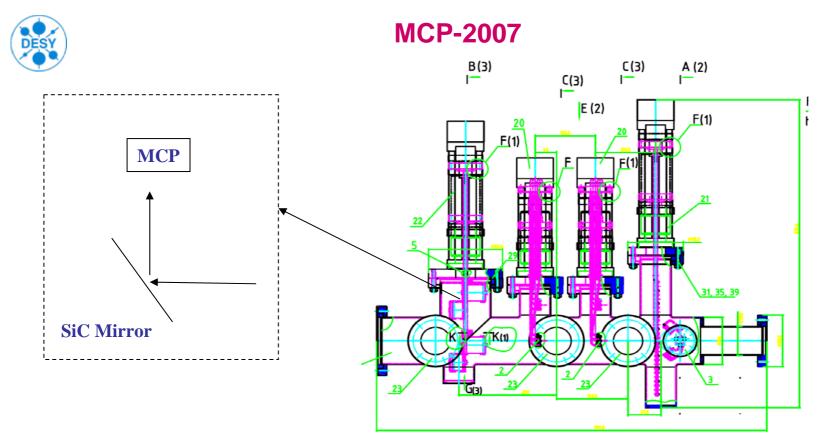
• MCP-2004 demonstrated good performance for SASE characterization and reliable detection of SASE radiation on top of background with winimum wavelength about 13 nm.

 Main limitation for detection of SASE above spontaneous emission (around 10 nm) is due to:

Drastical decrease of reflectivity -> increase of $HV \rightarrow$ higher gamma background (beam losses in the undulator and dump area).

• At 13 nm wavelength useful (photon) and background (gamma) signals become to be comparable at HV about 2000 V.

 Detection of short-wavelength radiation requires dedicated design.



•Best features of MCP-2004 are concerved: large and small-angle MCP detectors; duplication of MCP-detectors

- •Number of targets will be increased to 5:
- -Gold mesh identical to that of MCP-2004
- Two Cu meshes with 65 and 80% transmission
- Au wire will be replaced by Cu grid with 92% transmission
- -Mesh-attenuator with 2% transmission
- An MCP unit operating at lower HV will be added for reliable detection of shortwavelength radiation





•General design is finished

•In-vacuum parts (target holders) and electronics is manufacturing in Dubna, delivery is expected in April/May.

•Ordering of components and manufacturing of main vacuum chamber at DESY is expected to start in end of March / beginning of April.